

Vishay Siliconix

# N-Channel 250-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)	
250	0.058 at V <sub>GS</sub> = 10 V	45	
	0.062 at V <sub>GS</sub> = 6 V	43	

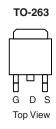
#### **FEATURES**

- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- · New Low Thermal Resistance Package

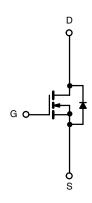


#### **APPLICATIONS**

- · Primary Side Switch
- Plasma Display Panel Sustainer Function



Ordering Information: SUM45N25-58-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> T <sub>C</sub> = 25 °C, un	less otherwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	250		
Typical Avalanche Voltage <sup>d</sup>		V <sub>DS (Avalanche)</sub> Typ	300	V	
Gate-Source Voltage		V <sub>GS</sub>	± 30		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C	L	45		
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	25	A	
Pulsed Drain Current		I <sub>DM</sub>	90	7 ^	
Avalanche Current		I <sub>AR</sub>	35		
Repetitive Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AR</sub>	61	mJ	
Mariana Danas Diaria kiand	T <sub>C</sub> = 25 °C	р	375 <sup>b</sup>	w	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	P <sub>D</sub>	3.75	\ \ \ \ \ \ \	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W	
Junction-to-Case (Drain)	R <sub>thJC</sub>	0.4		

#### Notes:

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When Mounted on 1" square PCB (FR-4 material).
- d. Guaranteed by design

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static	<u> </u>			L			
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	250			T .,	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 30 \text{ V}$			± 250	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V			1	μΑ	
		V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50		
		V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.047	0.058		
	_	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.121		
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C			0.163	Ω	
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 15 A		0.049	0.062		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		70		S	
Dynamic <sup>b</sup>				•			
Input Capacitance	C <sub>iss</sub>			5000		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		300			
Reverse Transfer Capacitance	C <sub>rss</sub>			170			
Total Gate Charge <sup>c</sup>	Qg			95	140	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 45 \text{ A}$		28			
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			34			
Gate Resistance	$R_{g}$	f = 1 MHz		1.6		Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			22	35	ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_{L} = 2.78 \Omega$		220	330		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 45 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		40	60		
Fall Time <sup>c</sup>	t <sub>f</sub>			145	220		
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>		•			
Continuous Current	I <sub>S</sub>				45		
Pulsed Current	I <sub>SM</sub>				70	Α	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 45 A, V <sub>GS</sub> = 0 V		1.0	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			150	225	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 45 A, di/dt = 100 A/μs		12	18	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.9	2	μC	

#### Notes:

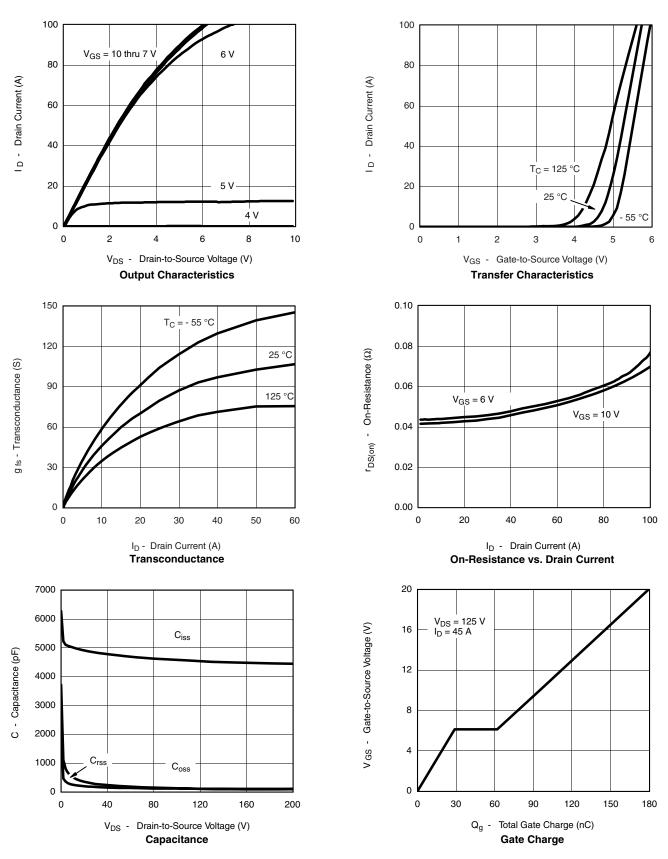
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

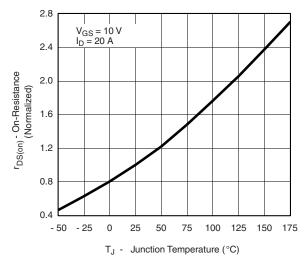


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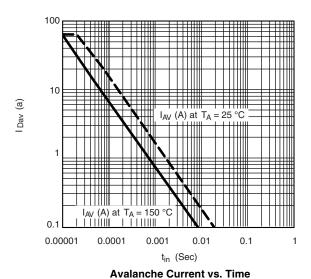
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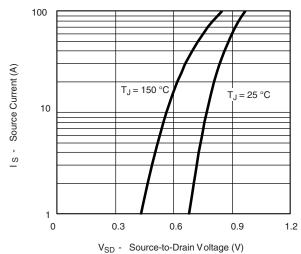
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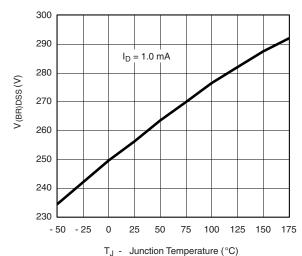


On-Resistance vs. Junction Temperature





Source-Drain Diode Forward Voltage

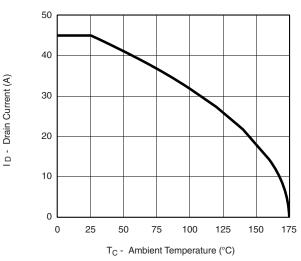


Drain Source Breakdown vs. Junction Temperature

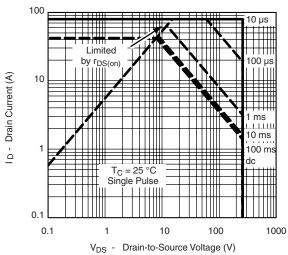


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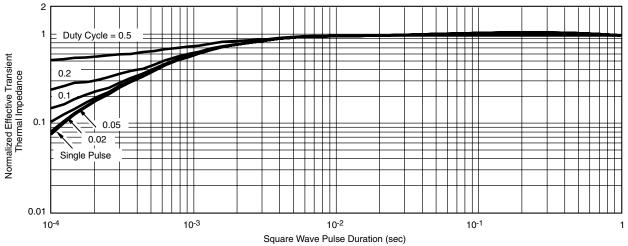
#### **THERMAL RATINGS**



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area, Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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